

TOSHIBA FIELD EFFECT TRANSISTOR SILICON P CHANNEL MOS TYPE (L²-π-MOSVI)

TPC8301

LITHIUM ION BATTERY

NOTE BOOK PC

PORTABLE MACHINES AND TOOLS

- Low Drain-Source ON Resistance : $R_{DS(ON)} = 95 \text{ m}\Omega$ (Typ.)
- High Forward Transfer Admittance : $|Y_{fs}| = 4 \text{ S}$ (Typ.)
- Low Leakage Current : $I_{DSS} = -10 \mu\text{A}$ (Max.) ($V_{DS} = -30 \text{ V}$)
- Enhancement-Mode : $V_{th} = -0.8 \sim -2.0 \text{ V}$
($V_{DS} = -10 \text{ V}$, $I_D = -1 \text{ mA}$)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Drain-Source Voltage		V_{DSS}	-30	V
Drain-Gate Voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	-30	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	DC	I_D	-3.5	A
	Pulse	I_{DP}	-14	A
Drain Power Dissipation*** (Ta = 25°C)		P_D	2.0	W
Single Pulse Avalanche Energy**		E_{AS}	16	mJ
Avalanche Current		I_{AR}	-3.5	A
Repetitive Avalanche Energy*		E_{AR}	0.2	mJ
Channel Temperature		T_{ch}	150	°C
Storage Temperature Range		T_{stg}	-55~150	°C

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MAX.	UNIT
Thermal Resistance, Channel to Ambient***	$R_{th(ch-a)}$	62.5	°C/W

Note ;

* Repetitive rating ; Pulse Width Limited by Max. Junction temperature.

** $V_{DD} = -24 \text{ V}$, $T_{ch} = 25^\circ\text{C}$ (initial), $L = 1.0 \text{ mH}$, $R_G = 25 \Omega$, $I_{AR} = -3.5 \text{ A}$

*** Drive operation ; Mount on glass epoxy board [1 inch² × 0.8 t] in the two devices driving (t = 10 s)

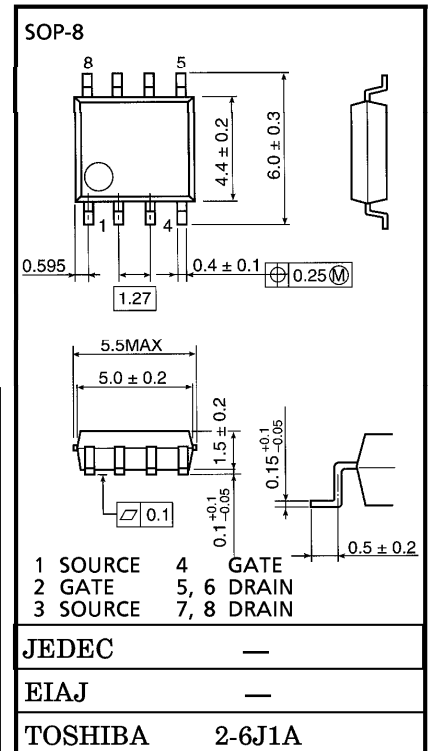
This transistor is an electrostatic sensitive device. Please handle with caution.

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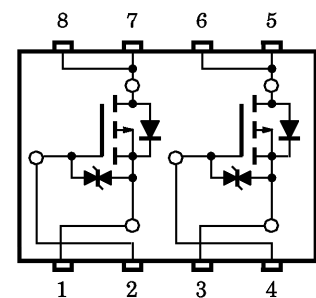
INDUSTRIAL APPLICATIONS

Unit in mm



Weight : 0.08 g

CIRCUIT CONFIGURATION



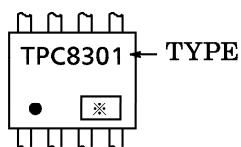
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		I_{GSS}	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	± 10	μA
Drain Cut-Off Current		I_{DSS}	$V_{DS} = -30\text{ V}, V_{GS} = 0\text{ V}$	—	—	-10	μA
Drain-Source Breakdown Voltage		$V_{(BR)DSS}$	$I_D = -10\text{ mA}, V_{GS} = 0\text{ V}$	-30	—	—	V
Gate Threshold Voltage		V_{th}	$V_{DS} = -10\text{ V}, I_D = -1\text{ mA}$	-0.8	—	-2.0	V
Drain-Source ON Resistance		$R_{DS(ON)}$	$V_{GS} = -4\text{ V}, I_D = -1.8\text{ A}$	—	155	190	$\text{m}\Omega$
		$R_{DS(ON)}$	$V_{GS} = -10\text{ V}, I_D = -1.8\text{ A}$	—	95	120	$\text{m}\Omega$
Forward Transfer Admittance		$ Y_{fs} $	$V_{DS} = -10\text{ V}, I_D = -1.8\text{ A}$	2	4	—	S
Input Capacitance		C_{iss}	$V_{DS} = -10\text{ V}, V_{GS} = 0\text{ V},$ $f = 1\text{ MHz}$	—	540	—	pF
Reverse Transfer Capacitance		C_{rss}		—	80	—	
Output Capacitance		C_{oss}		—	290	—	
Switching Time	Rise Time	t_r	<p>$I_D = -1.8\text{ A}$ $V_{GS} = 0\text{ V}$ -10 V 4.7Ω $R_L = 8.3\Omega$ $V_{DD} = -15\text{ V}$ $V_{IN} : t_r, t_f < 5\text{ ns}$ $\text{Duty} \leq 1\%, t_w = 10\text{ }\mu\text{s}$</p>	—	11	—	ns
	Turn-On Time	t_{on}		—	17	—	
	Fall Time	t_f		—	11	—	
	Turn-Off Time	t_{off}		—	70	—	
Total Gate Charge (Gate-Source Plus Gate-Drain)		Q_g	$V_{DD} = -24\text{ V}, V_{GS} = -10\text{ V},$ $I_D = -3.5\text{ A}$	—	18	—	nC
Gate-Source Charge		Q_{gs}		—	13	—	
Gate-Drain ("Miller") Charge		Q_{gd}		—	5	—	

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	I_{DR}	—	—	—	-3.5	A
Pulse Drain Reverse Current	I_{DRP}	—	—	—	-14	A
Diode Forward Voltage	V_{DSF}	$I_{DR} = -3.5\text{ A}, V_{GS} = 0\text{ V}$	—	—	1.2	V

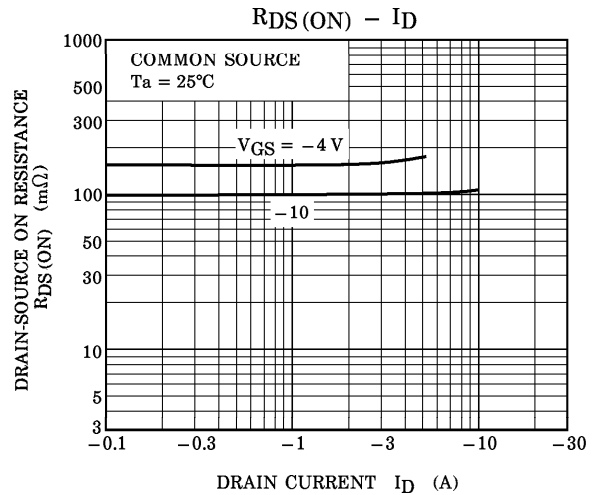
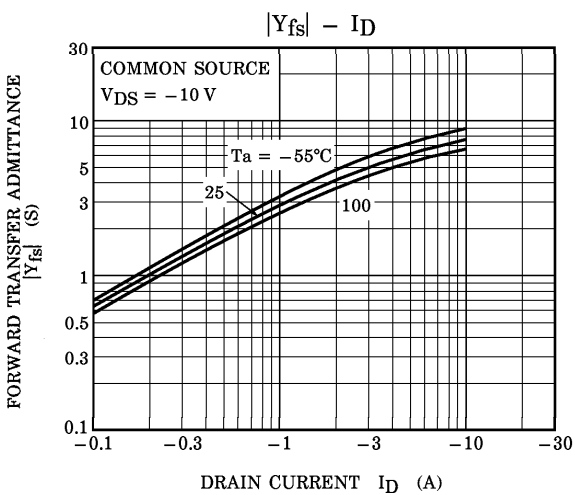
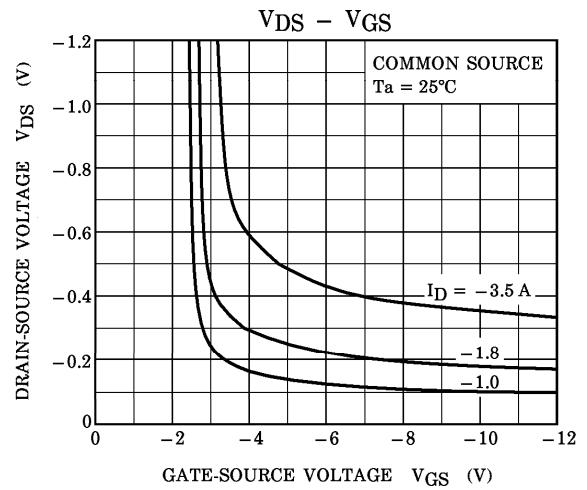
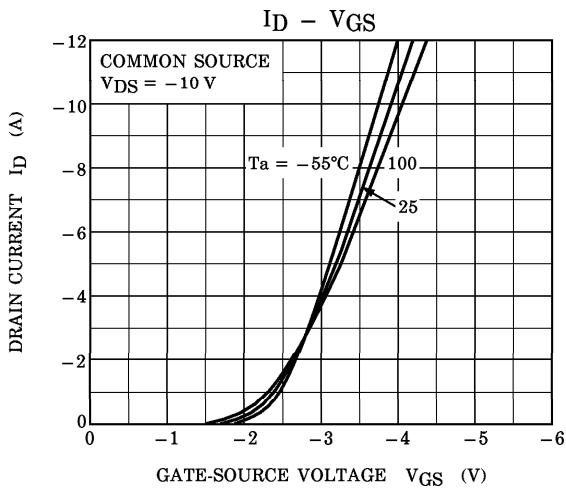
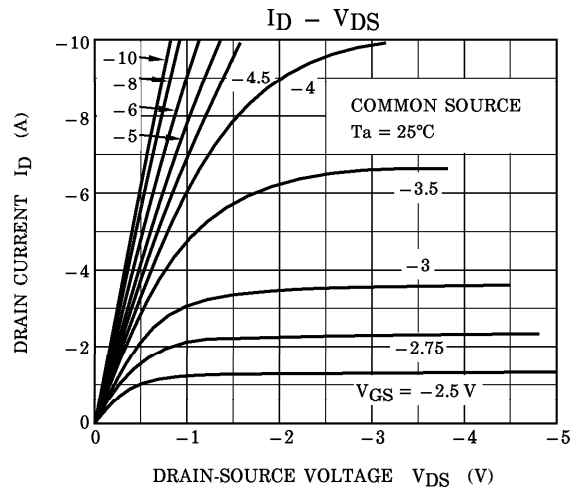
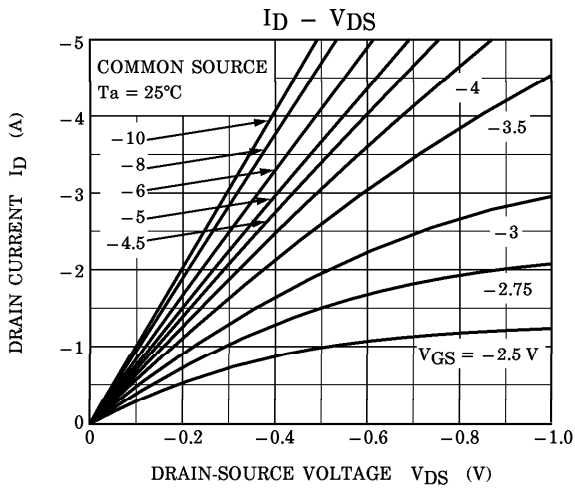
MARKING

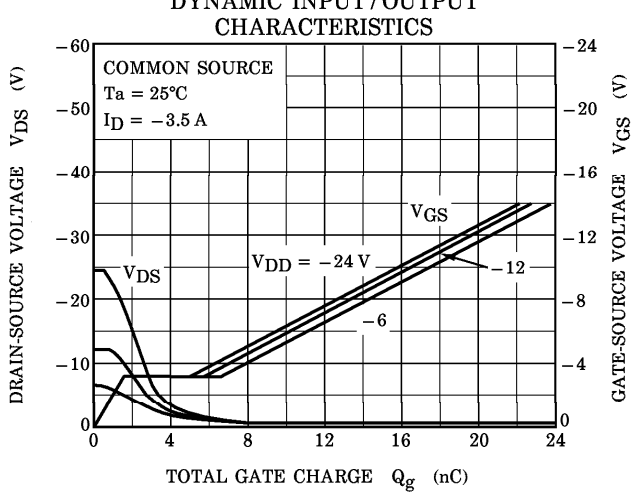
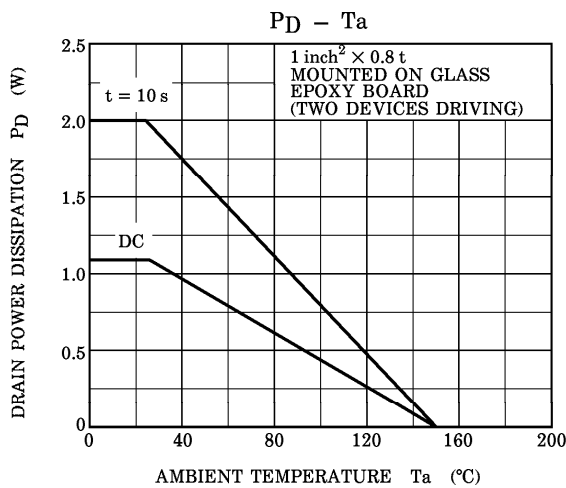
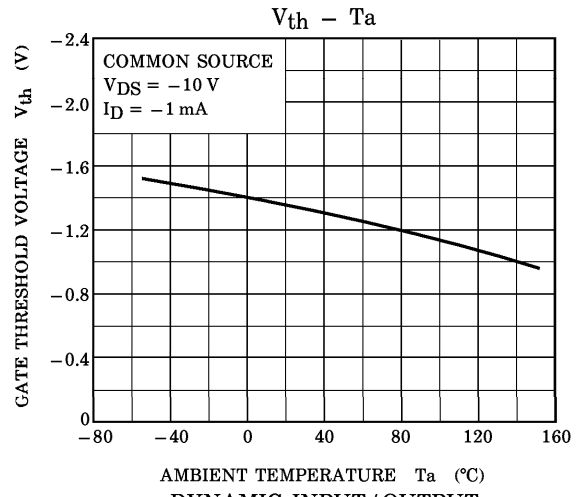
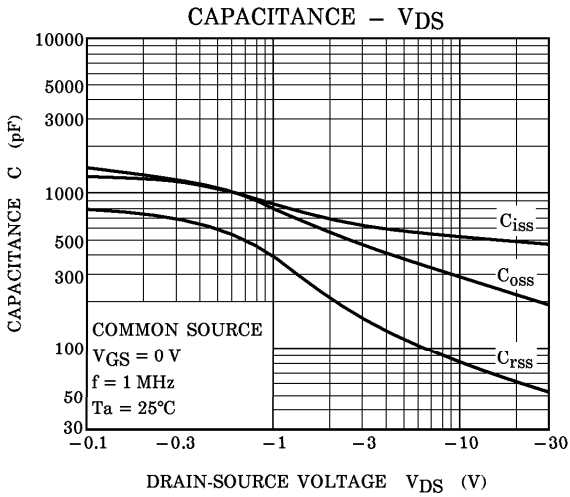
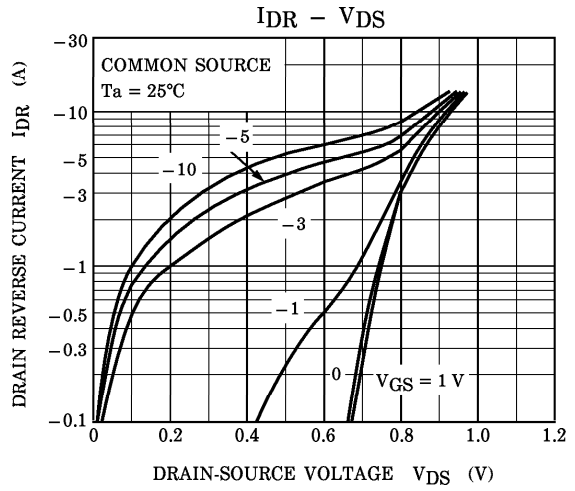
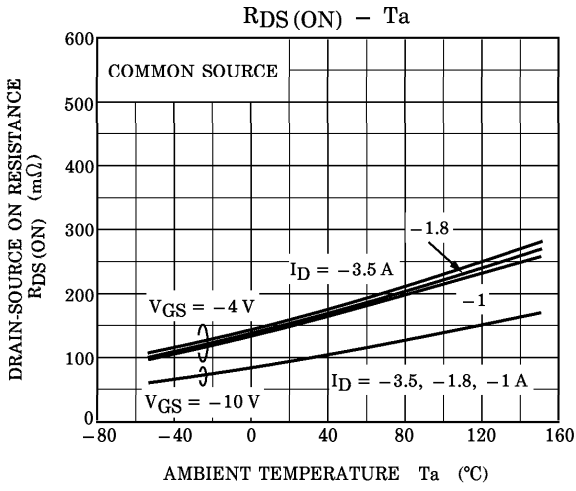


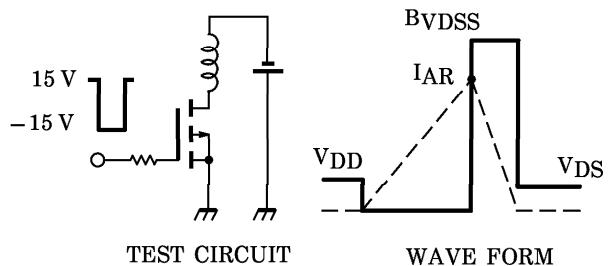
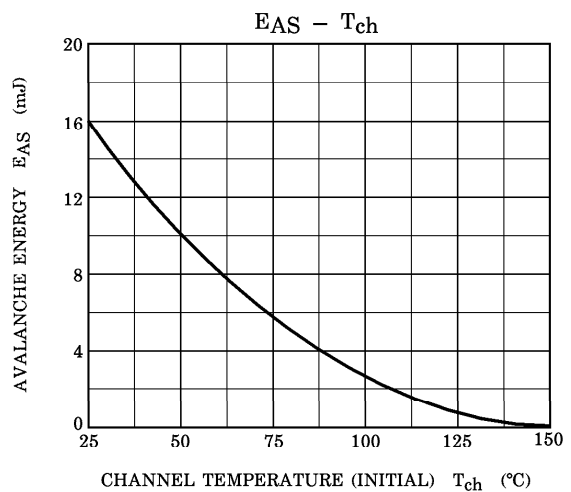
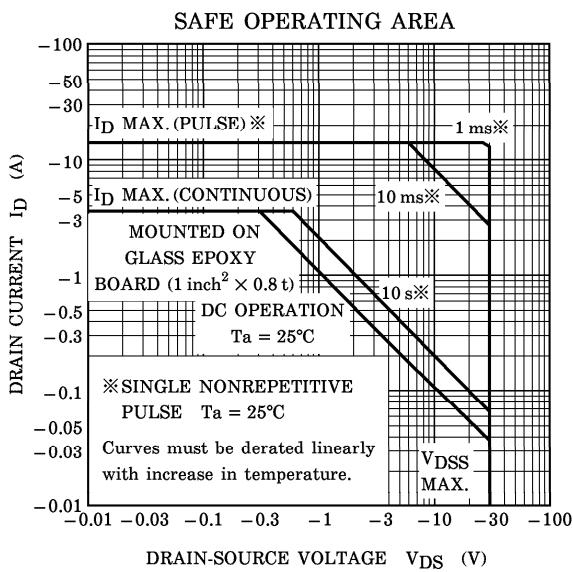
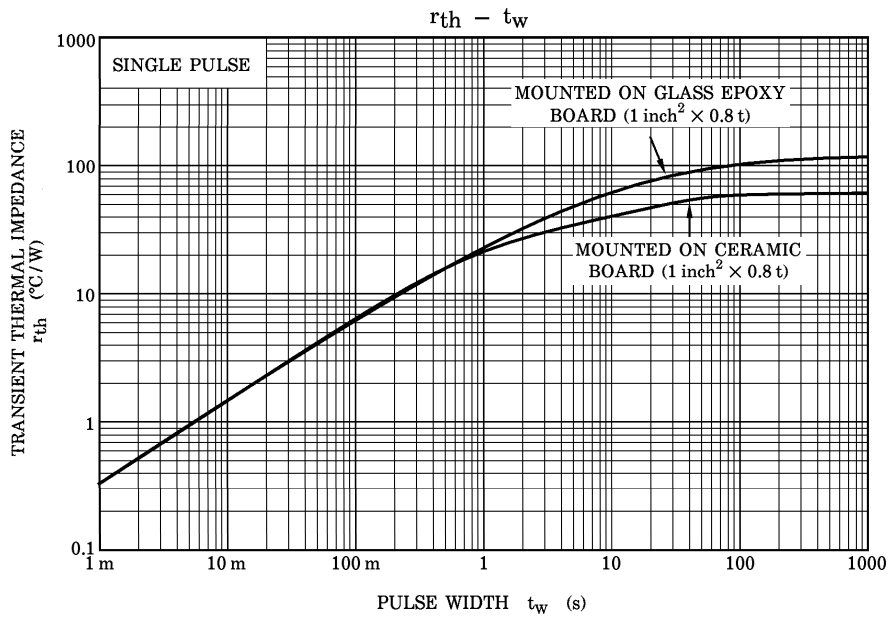
※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)







Peak $I_{AR} = -3.5 \text{ A}$, $R_G = 25 \Omega$ $E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{BVDSS}{BVDSS - V_{DD}} \right)$
 $V_{DD} = -24 \text{ V}$, $L = 1.48 \text{ mH}$